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	Filing Date		2007-06-01	
	First Named Inventor	Gerwi	in Hermanus Gelinck	
	Art Unit		2814	
	Examiner Name	John (	C. Ingham	
	Attorney Docket Number		NL031508US1	

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	1	G.H. Gelinck, "High-performance all-polymer integrated circuits", Applied Physics Letters, Vol. 77, no. 10, September 4, 2000, pages 1487-1489					
	2	F.J. Touwslager et al, "I-Line lithography of poly-(3,4-ethylenedioxythiophene) electrodes and application in all-polymer integrated circuits", Applied Physics Letters, Vol. 81, No. 24, December 9, 2002, pages 4556-4558					
	3	M.E. Lines et al, "Principles and Applications of Ferroelectrics and Related Materials", Oxford Press, 2001					
	4 "Ferroelectric Polymers, Chemistry, Physics and Applications", edited by Hari Singh Nalwa, Marcel Dekker, Inc, 1995						
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